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6. ☐ Interview S Paper No 08), 7. ☐ Examiner' 8. ⊠ Examiner'	Summary (PTO-413), b./Mail Date s Amendment/Comment s Statement of Reasons for Alle	
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## **DETAILED ACTION**

1. This office action is in response to application 09/708,572 and amendment filed on 10/4/2004. Claims 1, 5, and 9-14 remain pending in the application.

## **EXAMINER'S STATEMENT AS TO THE REASONS FOR ALLOWANCE**

- 2. Claims 1, 5 and 9-14 are allowed over the prior art of record.
- 3. The following is an examiner's statement of reasons for allowance: as to claims 1, 5 and 9-14, the prior art of record does not teach or fairly suggest a method for designing a hierarchical layout of a circuit comprising obtaining/retrieving/acquiring first design layout data of a lower rank of hierarchy of the hierarchical layout; obtaining/retrieving/acquiring second layout design data (including wiring layout design data) of a rank of hierarchy higher than the lower rank of the hierarchy, after obtaining the first design data; combining the second design layout design data to the first design layout data, wherein when the first design layout of the lower rank of the hierarchy is modified after the second design layout data is created (setting the wiring data of an upper rank from the hierarchy in the design layout data and displaying the second design layout data together with the first design data of the lower rank of the hierarchy), the second design layout data is displayed together with the first design data of the lower rank of the hierarchy, and wherein the hierarchy comprises a physical hierarchy including a plurality of ranks having different physical heights.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably

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accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

## Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Vuthe Siek whose telephone number is (571) 272-1906. The examiner can normally be reached on Increase Flextime.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew Smith can be reached on (571) 272-1907. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

**Vuthe Siek** 

VUTHE SIEK
PRIMARY EXAMINER